



COST

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and Environmental Sustainability - *EuNetAir*

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Towards sensitive air quality monitoring exemplified by the field effect sensor platform

From chemical interactions to electrical transduction

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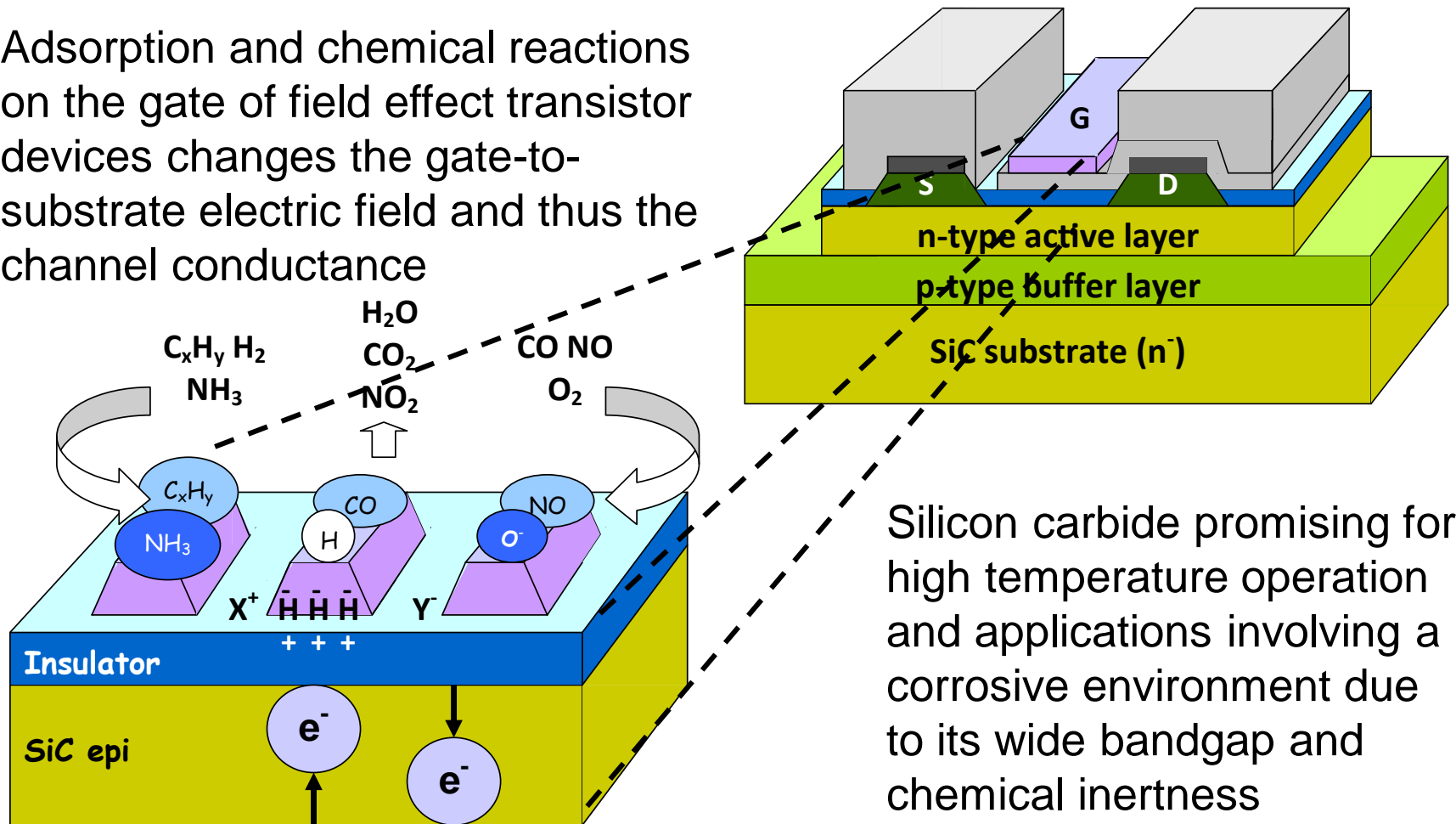


Outline

- **Field effect sensor technology – overview**
- **FET sensor signal transduction – overview**
- **FET transducer design**
 - **Device type**
 - **Influence of gate length**
- **FET operation**
 - **Influence of gate bias**
- **FET materials design – chemical interactions**
 - **Influence of gate insulator**
 - **Influence of gate structure**
 - **Influence of gate material**
- **Example**

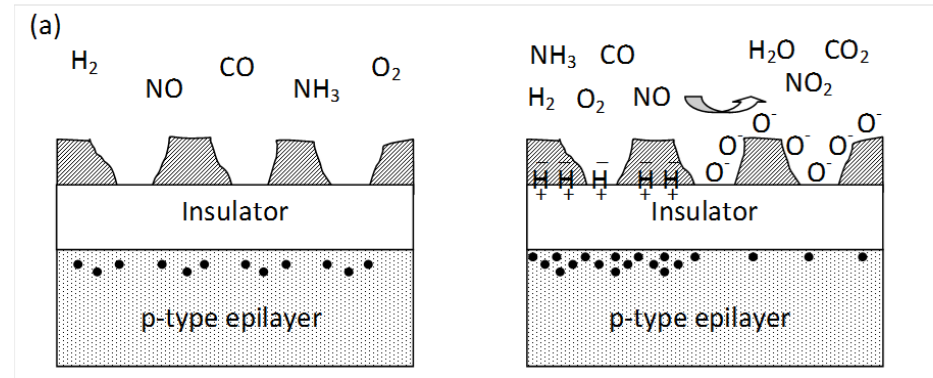
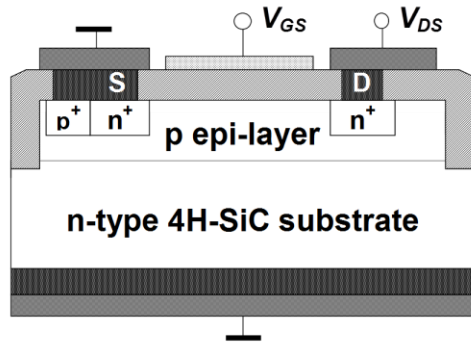
Overview – Field effect sensor technology

Adsorption and chemical reactions on the gate of field effect transistor devices changes the gate-to-substrate electric field and thus the channel conductance



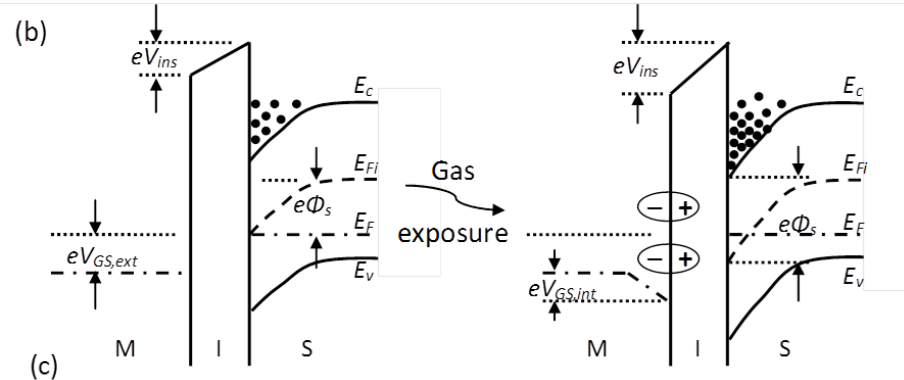
Silicon carbide promising for high temperature operation and applications involving a corrosive environment due to its wide bandgap and chemical inertness

Overview – FET sensor signal transduction

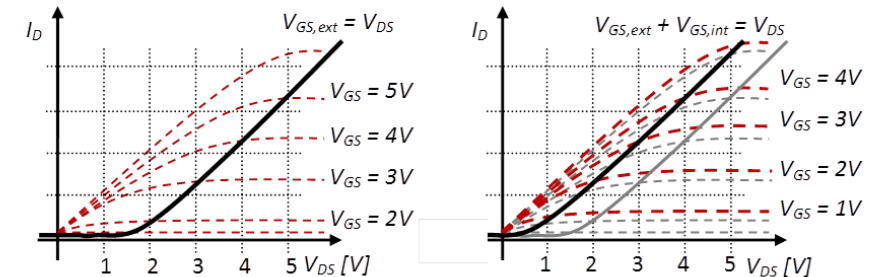


$$I_{D,sat} = \frac{W \mu_n \epsilon_{ins}}{2L d_{ins}} [V_{GS} - V_T]^2$$

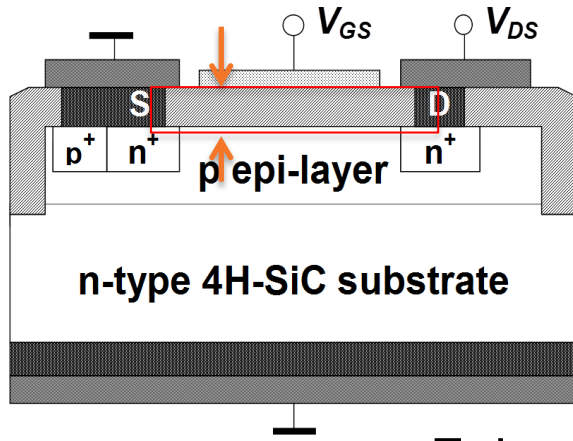
$$V_T = \frac{2d_{ins} [eN_a \epsilon_s \Phi_F]^{1/2}}{\epsilon_{ins}} - \frac{Q_{SS} d_{ins}}{\epsilon_{ins}} + \Phi_{ms} + 2\Phi_F$$



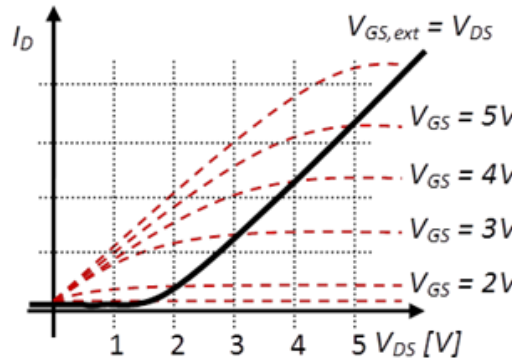
$$g_{m,sat} = \frac{\partial I_{D,sat}}{\partial V_{GS}} = \frac{W \mu_n \epsilon_{ins}}{L d_{ins}} [V_{GS} - V_T]$$



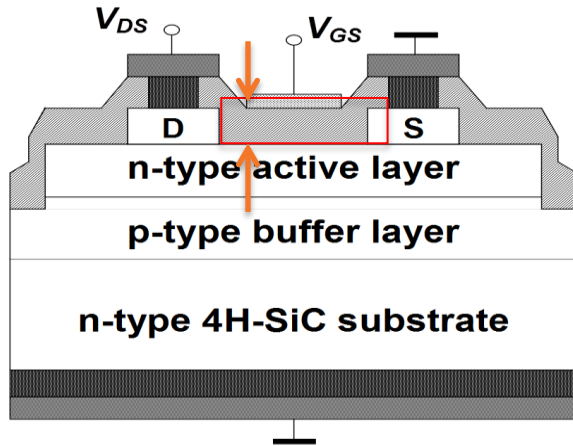
FET transducer – influence of device type



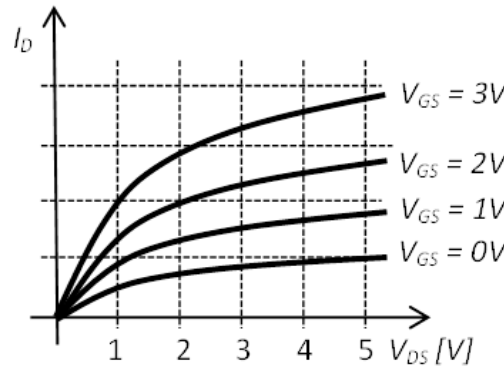
Enhancement type



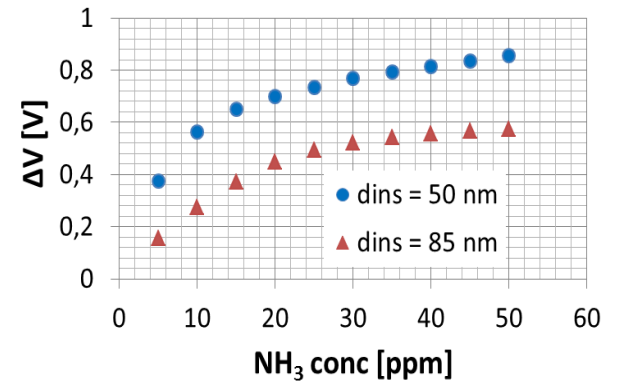
Low gate-to-substrate field
=>
thin gate dielectrics



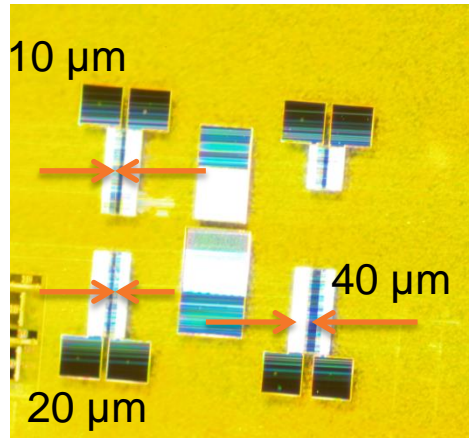
Depletion type



$$g_{m,sat} = \frac{\partial I_{D,sat}}{\partial V_{GS}} = \frac{W \mu_n \epsilon_{ins}}{L d_{ins}} [V_{GS} - V_T]$$

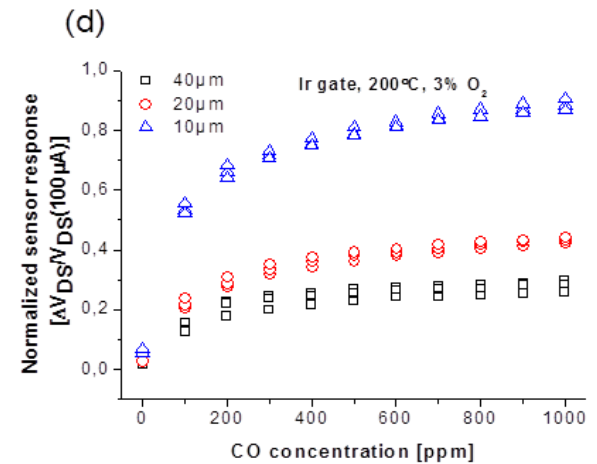
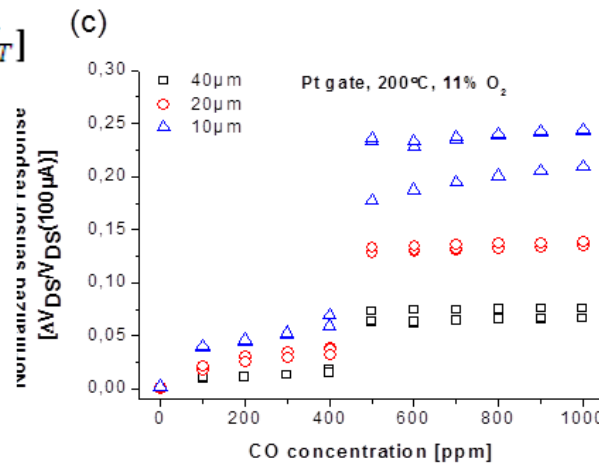
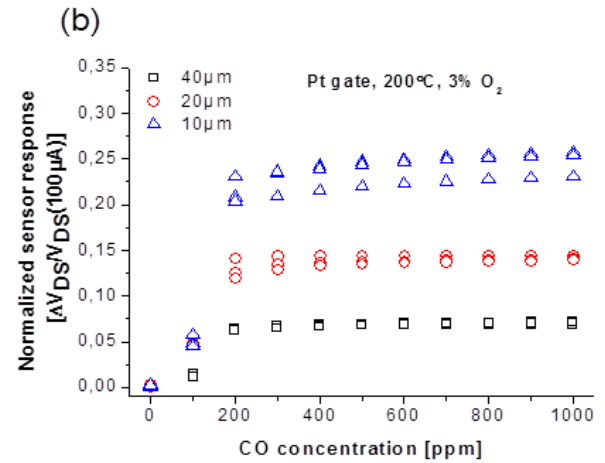
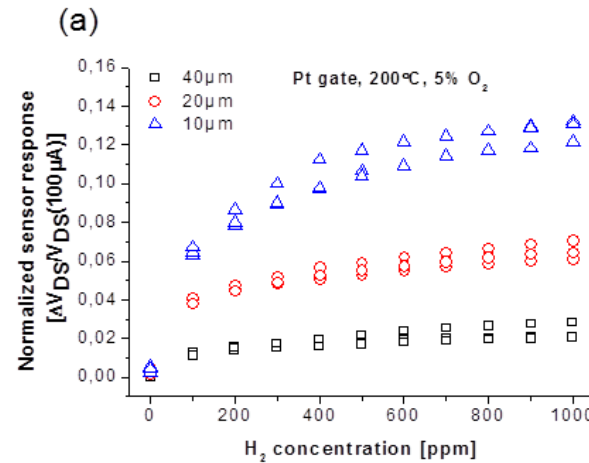


FET transducer – influence of gate length

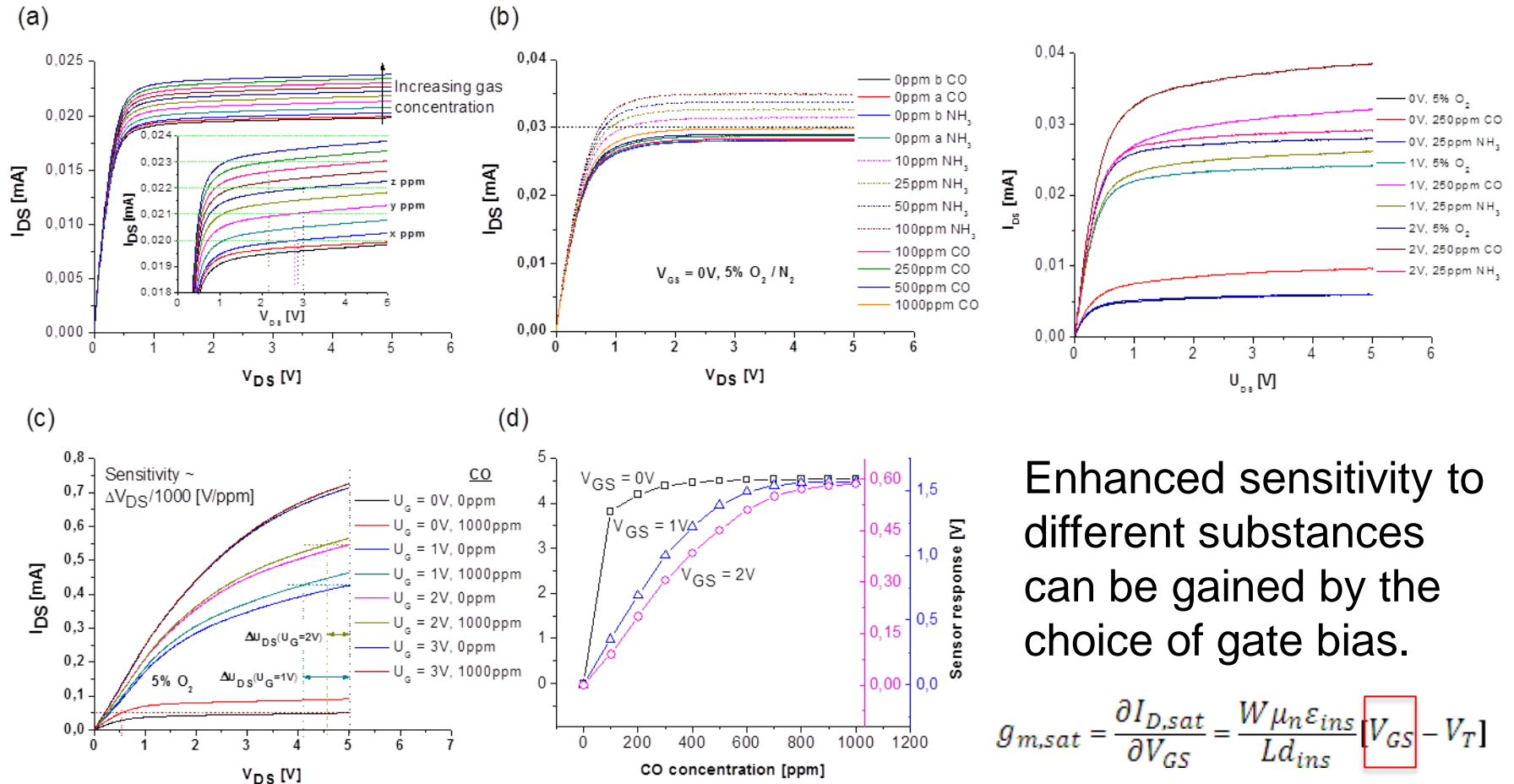


$$g_{m,sat} = \frac{\partial I_{D,sat}}{\partial V_{GS}} = \frac{W}{L} \frac{\mu_n \epsilon_{ins}}{d_{ins}} [V_{GS} - V_T]$$

The wider or shorter the gate the more sensitive to V_{GS} changes



FET transducer – influence of gate bias



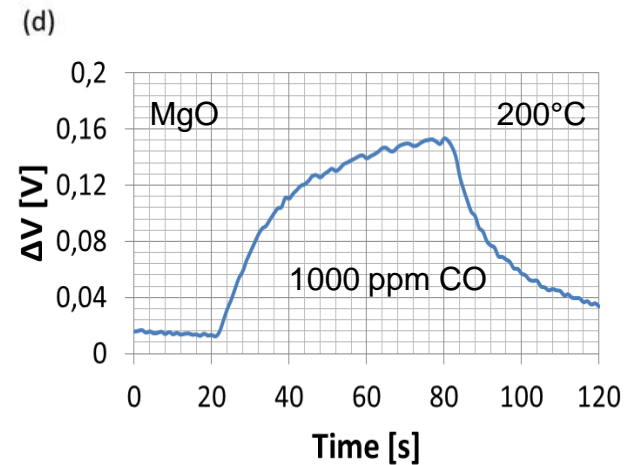
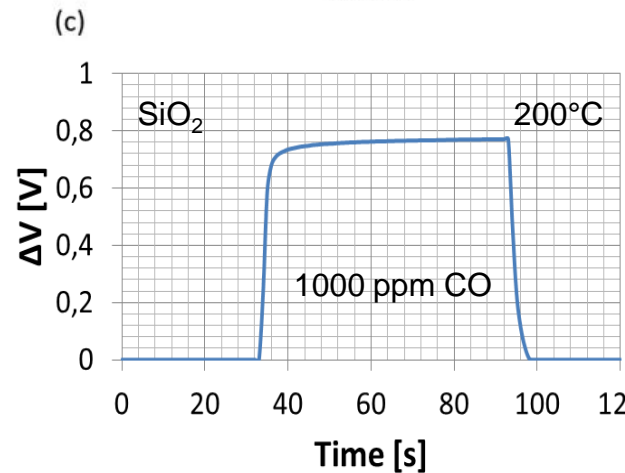
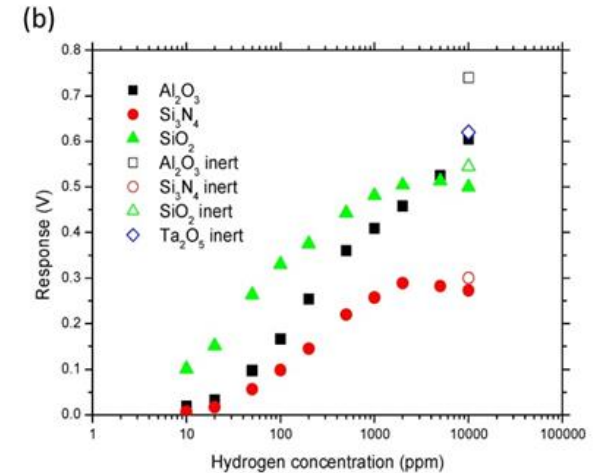
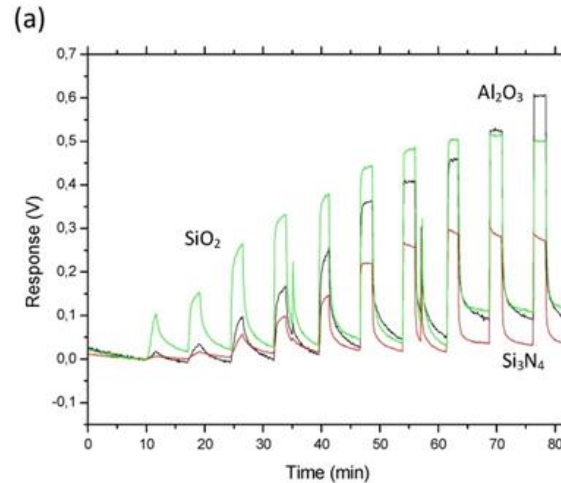
Enhanced sensitivity to different substances can be gained by the choice of gate bias.

$$g_{m,sat} = \frac{\partial I_{D,sat}}{\partial V_{GS}} = \frac{W \mu_n \epsilon_{ins}}{L d_{ins}} [V_{GS} - V_T]$$

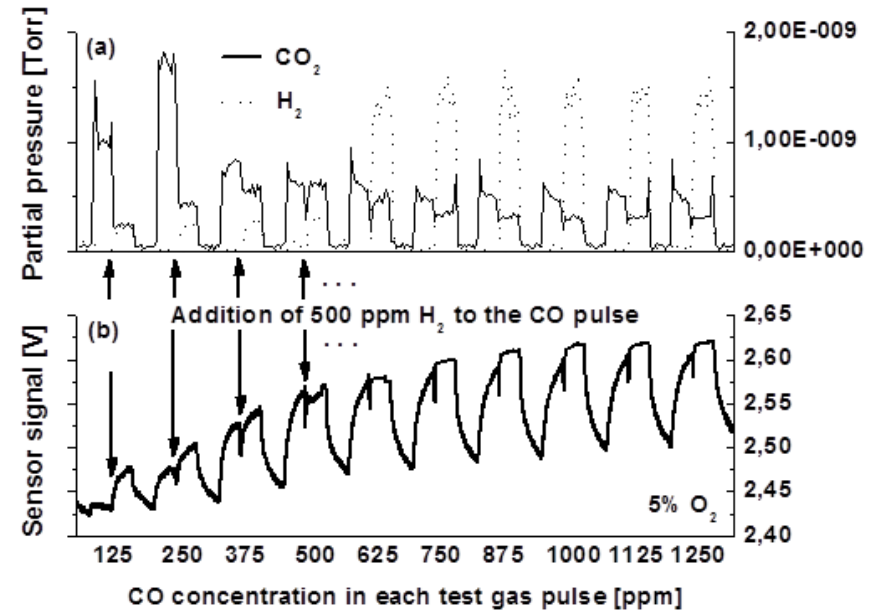
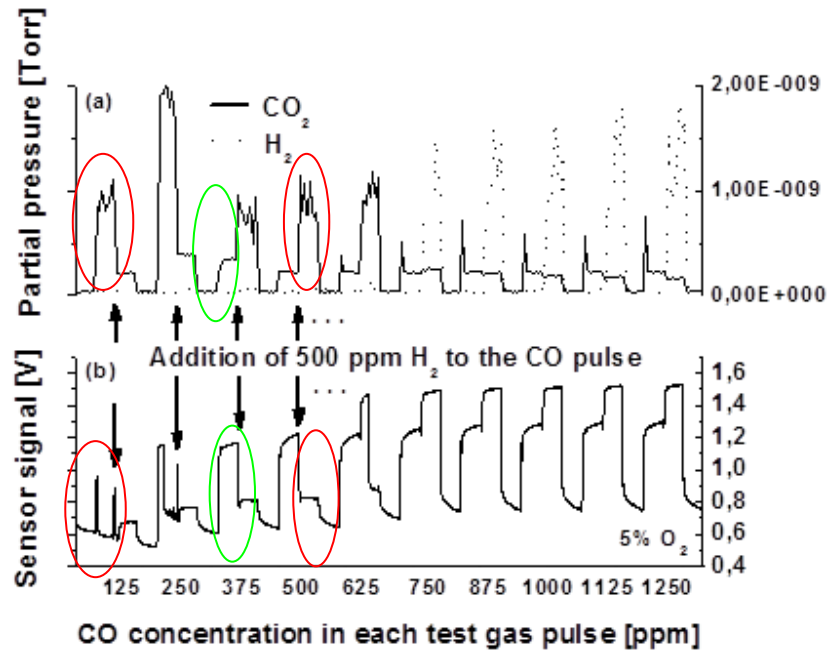
Materials design – influence of gate insulator

Depending on the density of adsorption sites, the enthalpy of adsorption and its dependency on coverage, different insulator materials/ surfaces exhibit different dynamic ranges for the gas response

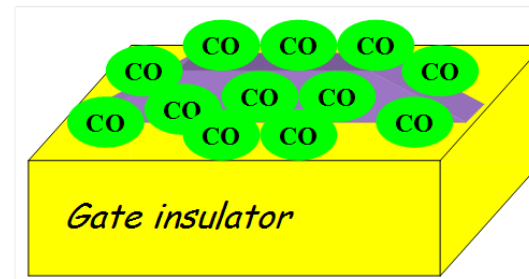
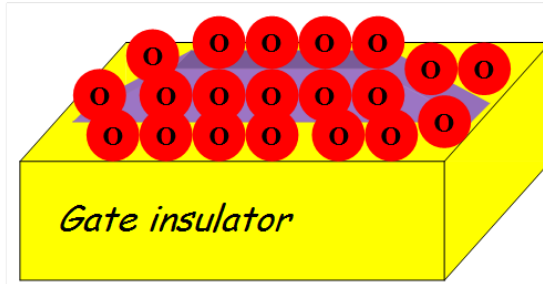
$$\Delta V_{\text{int}} = n_H \cdot p / \epsilon$$



Materials design – influence of gate stack

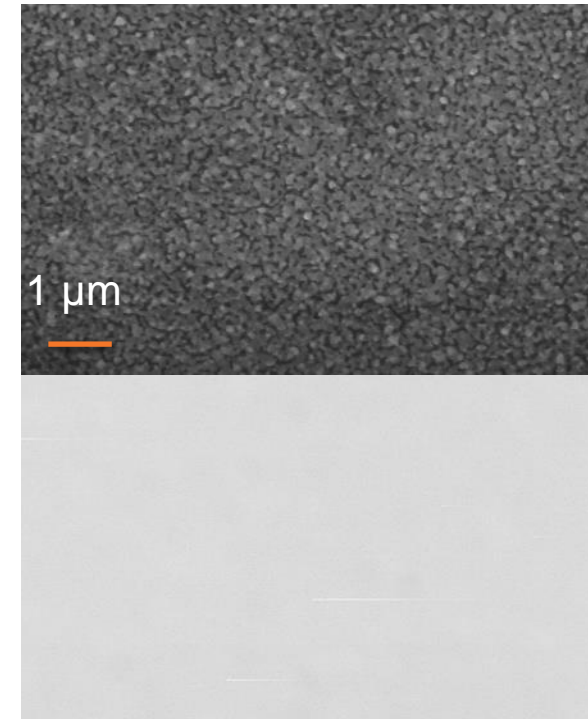
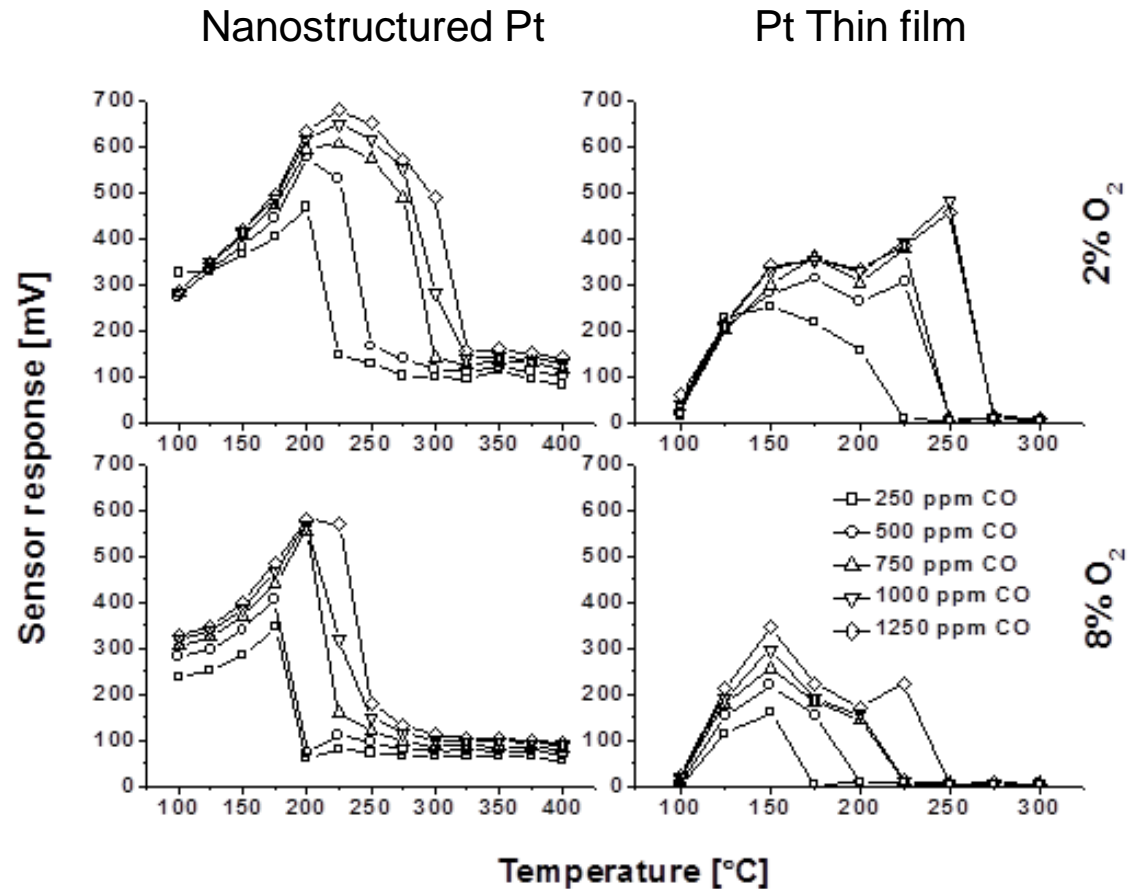


M	Pt
O	SiO ₂
S	SiC

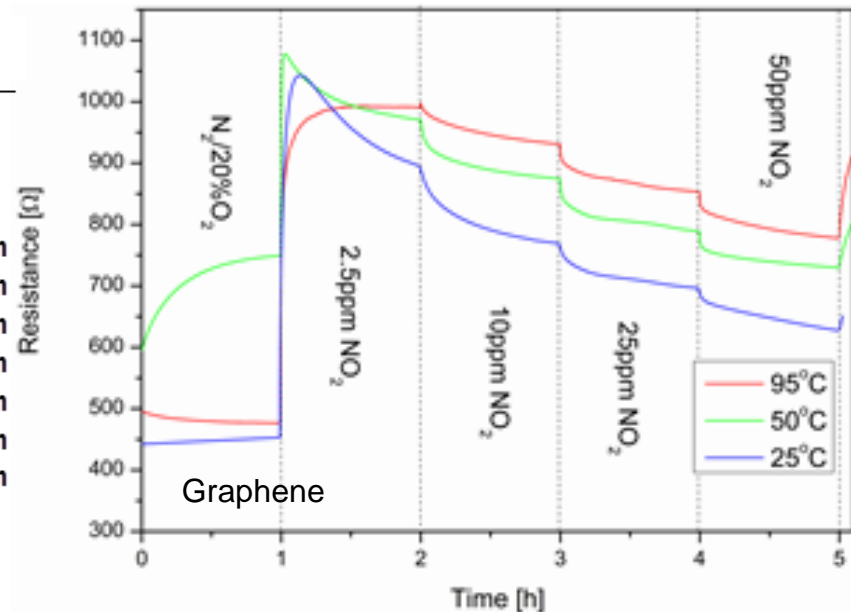
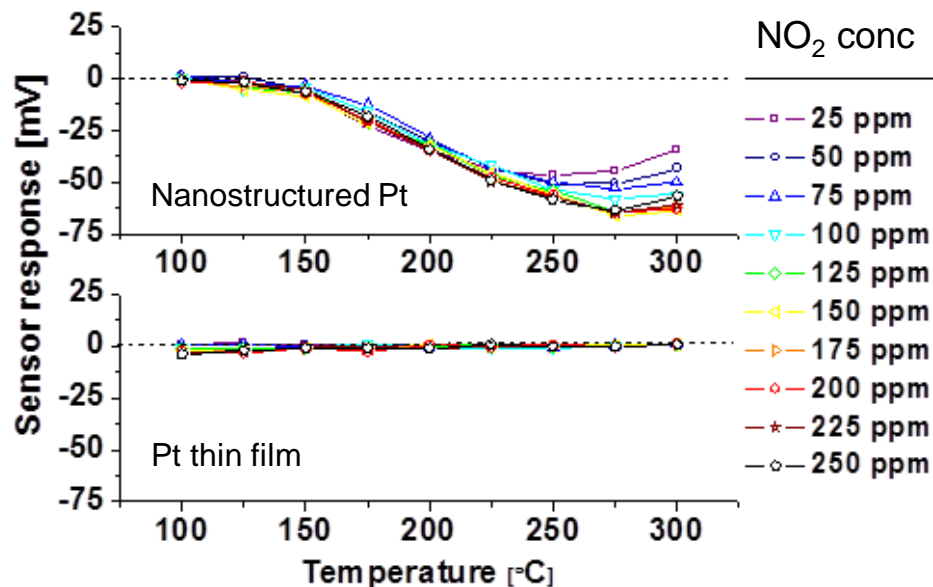


Pt
MgO
SiO ₂
SiC

Materials design – influence of gate structure



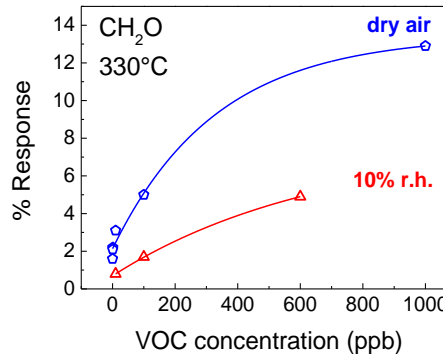
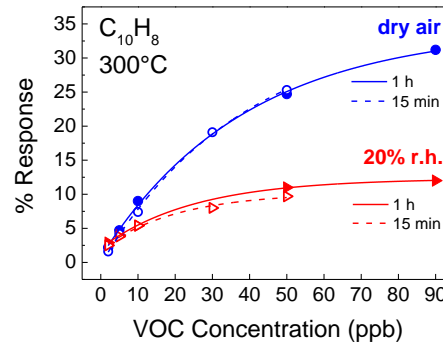
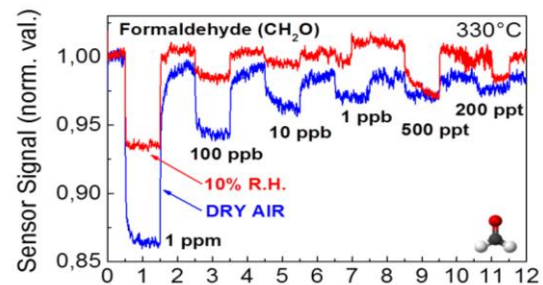
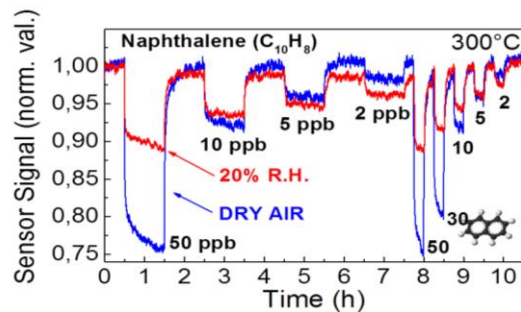
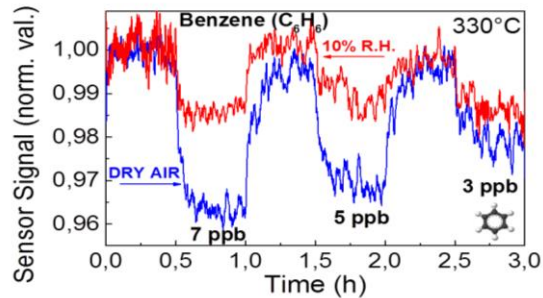
Materials design – influence of gate material



Comparison of the changes in sensor signal upon NO₂ exposure between nanostructured Pt, thin film Pt and graphene at low operation temperatures

Example

Highly sensitive sensor devices under development for VOC measurements for indoor air quality monitoring applications in cooperation with Saarland University, Germany, to be continued in the EU FP7 project SENSIndoor

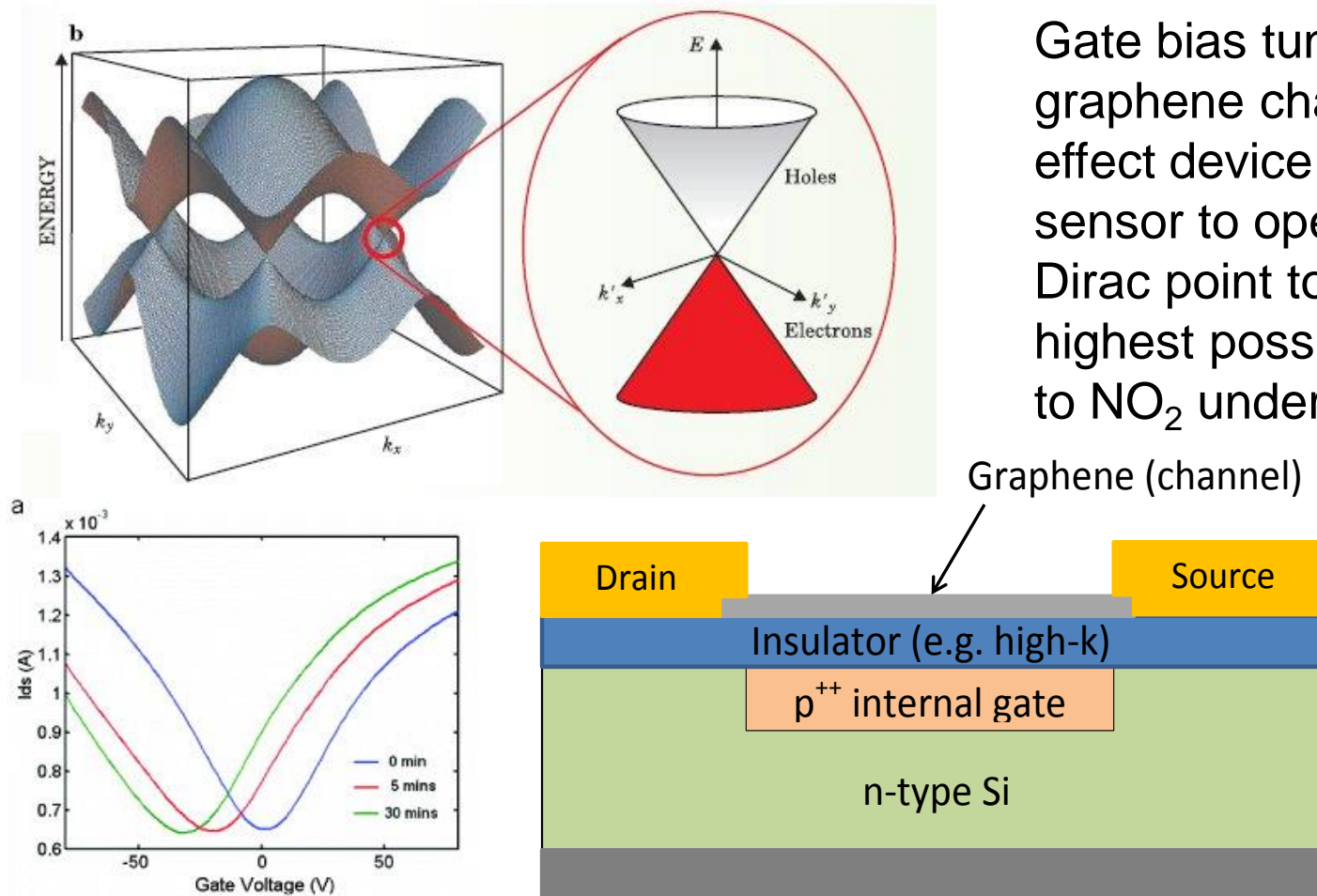


Measurements performed by Donatella Puglisi and Christian Bur at Saarland University, Laboratory for Measurement Technology



Example

Gate bias tuning of a graphene channel field effect device to adjust the sensor to operate at the Dirac point to ensure highest possible sensitivity to NO_2 under all conditions



A microscopic view of a silicon wafer, showing a grid of individual dies. The dies are arranged in a regular pattern and have a reddish-brown color. The wafer is held in a green frame.

Thank you for your attention!